

16SYQ060C

16 Amp. 60V

SCHOTTKY RECTIFIER HIGH EFFICIENCY SERIES

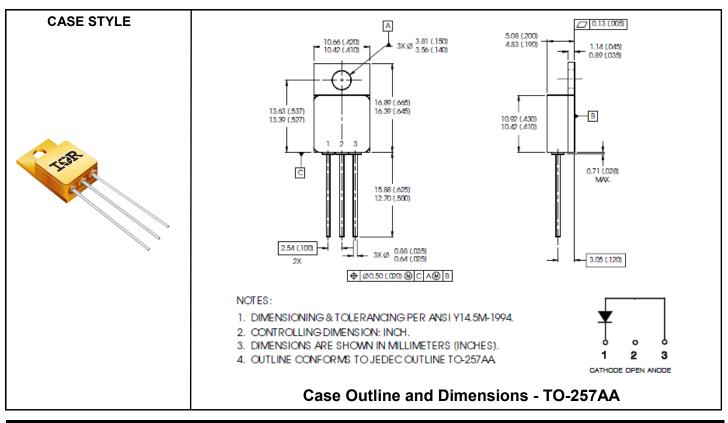
Major Ratings and Characteristics

Characteristics	16SYQ060C	Units
I _{F(AV)}	16	А
V _{RRM}	60	V
I_{FSM} @ tp = 8.3ms half–sine	250	А
V _F @ I _F = 16Apk, T _J = 125°C	0.63	V
T_J , T_{STG} Operating and storage	-55 to 150	°C

Description/Features

The 16SYQ060C Schottky rectifier has been expressly designed to meet the rigorous requirements of hirel environments. It is packaged in the hermetic isolated TO-257AA ceramic package. The device's forward voltage drop and reverse leakage current are optimized for the lowest power loss and the highest circuit efficiency for typical high frequency switching power supplies and resonent power converters. Full MIL-PRF-19500 quality conformance testing is available on source control drawings to TX, TXV and S quality levels.

- Hermetically Sealed
- Ceramic Eyelets
- Low Forward Voltage Drop
- High Frequency Operation
- Guard Ring for Enhanced Ruggedness and Long term Reliability
- Lightweight



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Voltage Ratings

OO	
Part Number	16SYQ060C
V _R DC Reverse Voltage (V), maximum	<u></u>
V _{RRM} Working Peak Reverse Voltage (V), maximum	60

Absolute Maximum Ratings

	Parameter		Units	Conditions
I _{F(AV)}	Maximum Average Forward Current See Fig. 5	16	А	50% duty cycle @ T_c = 125°C, square waveform
I _{FSM}	Maximum Peak One Cycle Non - Repetitive Surge Current	250	A	tp = 8.3 ms half-sine

Electrical Specifications

	Parameter	Limits	Units		Conditions
	Maximum Forward Voltage Drop	0.66	V	I _F = 16A	T _J = -55°C
		0.87	V	I _F = 32A	
		0.65	V	I _F = 16A	T _J = 25°C
	See Fig. 1 ①	0.94	V	I _F = 32A	
		0.63	V	I _F = 16A	T = 125°C
		1.04	V	I _F = 32A	T _J = 125°C
$I_{\rm RM}$	Maximum Reverse Leakage Current	0.5	mA	T _J = 25°C	
	See Fig. 20	50	mA	T _J = 100°C	V_R = rated V_R
		275	mA	T _J = 125°C	
CJ	Maximum Junction Capacitance	2100	рF	$V_R = 5V_{DC} (1MHz, 25^{\circ}C)$	
Ls	Typical Series Inductance	9.8	nH	Measured from anode lead to cathode lead 6mm (0.025 in.) from package	

Thermal-Mechanical Specifications

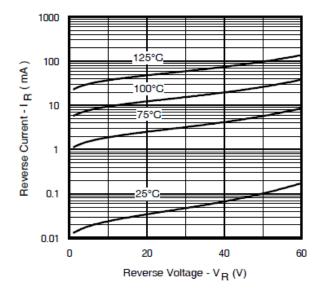
	Parameter	Limits	Units	Conditions
ΤJ	Maximum Junction Temperature Range	-55 to 150	°C	
T _{stg}	Maximum Storage Temperature Range	-55 to 150	°C	
R _{thJC}	Maximum Thermal Resistance, Junction to Case	1.15	°C/W	DC operation See Fig. 4
Wt	Weight, typical	4.3	g	
	Die Size (Typical)	200 X 200	mils	
	Case Style	T0-257AA		

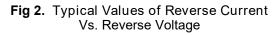
0 Pulse Width < 300µs, Duty Cycle < 2%.

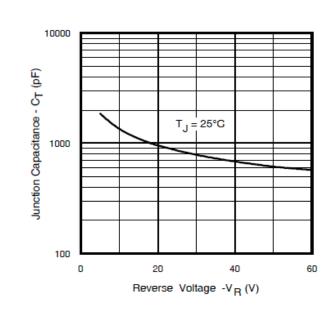


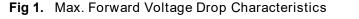
100

Instantaneous Forward Current - I $_{\rm F}$ (A) $_{\rm DI}$









0.6

Forward Voltage Drop - V F (V)

Tj = 125°C

Tj = 25°C

Tj = -55°C

0.8

1.0

1.2

Fig 3. Typical Junction Capacitance Vs. Reverse Voltage

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1 L

0.2

0.4



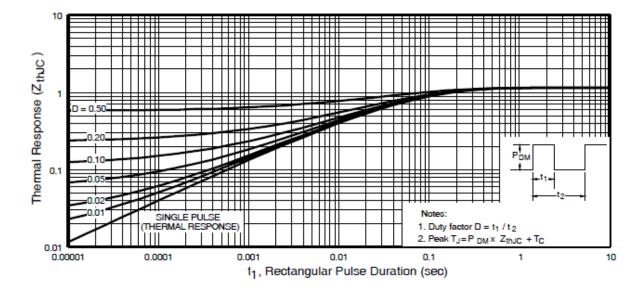
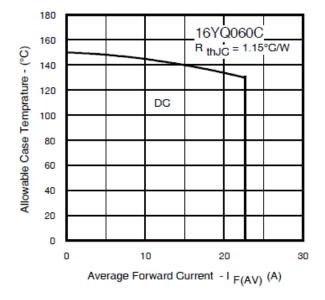
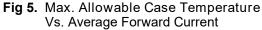


Fig 4. Max. Thermal Impedance Z_{thJC} Characteristics







Infineon Technologies Service Center: USA Tel: +1 (866) 951-9519 and International Tel: +49 89 234 65555 Leominster, Massachusetts 01453, USA Tel: +1 (978) 534-5776 San Jose, California 95134, USA Tel: +1 (408) 434-5000 Data and specifications subject to change without notice.



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